

MULTI-INNO TECHNOLOGY CO., LTD.

www.multi-inno.com

LCD MODULE SPECIFICATION

Model : MI0600BT

For Customer's Acceptance:

Customer	
Approved	
Comment	

Revision	2.2
Engineering	
Date	2012-02-22
Our Reference	



REVISION RECORD

REV NO.	REV DATE	CONTENTS	REMARKS
1.0	2009-08-02	First Release	
2.0	2009-10-21	Add LED life time	
2.1	2010-04-26	Update power consumption	
2.2	2012-02-22	Update viewing direction	



CONTENTS

- GENERAL INFORMATION
- EXTERNAL DIMENSIONS
- ABSOLUTE MAXIMUM RATINGS
- ELECTRICAL CHARACTERISTICS
- BACKLIGHT CHARACTERISTICS
- ELECTRO-OPTICAL CHARACTERISTICS
- INTERFACE DESCRIPTION
- BLOCK DIAGRAM
- APPLICATION NOTES
- RELIABILITY TEST
- INSPECTION CRITERION
- PRECAUTIONS FOR USING LCD MODULES
- PRIOR CONSULT MATTER



■ GENERAL INFORMATION

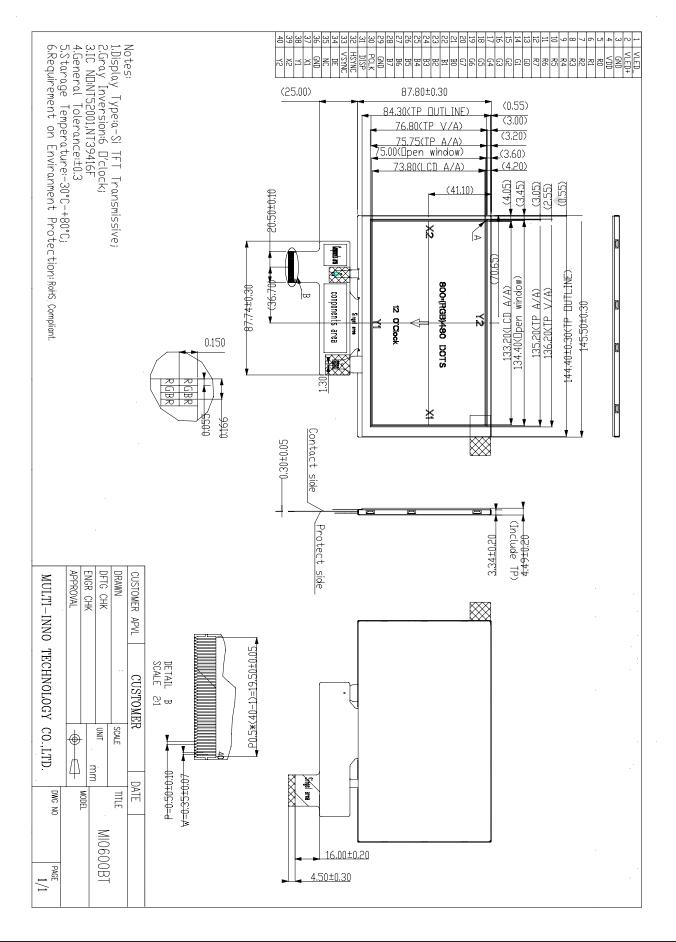
Item	Contents	Unit
LCD type	TFT/Transmissive/Normally white	/
Size	6.0	Inch
Viewing direction	12:00	O' Clock
Gray scale inversion direction	6:00	O' Clock
$LCM(W \times H \times D)$	145.50×87.80×4.50	mm ³
Active area (W×H)	133.20×73.80	mm ²
Pixel pitch (W×H)	0.1665×0.1538	mm ²
Number of dots	800 (RGB) × 480	/
Driver IC	NT52001,NT39416F	/
Backlight type	21 LEDs	/
Interface type	RGB 24 bits with TCON	/
Color depth	16M	/
Pixel configuration	R.G.B vertical stripe	/
Surface treatment(Up polarizer)	Anti glare	/
Surface treatment(TSP)	Anti glare	/
Input voltage	3.3	V
With/Without TSP	With TSP	/
Weight	117.9	g

Note 1:Viewing direction for best image quality is different from TFT definition, there is a 180 degree shift. Note 2 : RoHS compliant;

Note 3: LCM weight tolerance: \pm 5%.



EXTERNAL DIMENSIONS





■ABSOLUTE MAXIMUM RATINGS

Parameter	Symbol	Min	Max	Unit
Supply voltage	VDD	-0.5	5.0	V
Back light forward current	I led	-	25	mA
Operating temperature	Тор	-20	60	°C
Storage temperature	Тѕт	-30	70	°C
Humidity	RH	-	90%(Max60°C)	RH

ELECTRICAL CHARACTERISTICS

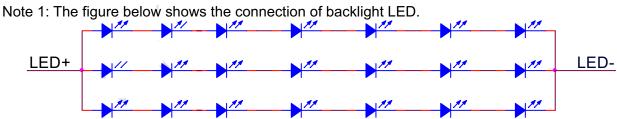
DC CHARACTERISTICS

Parameter	Symbol	Min	Тур	Max	Unit
Logic supply voltage	VDD	2.7	3.3	3.6	V
Input voltage ' H ' level	Vih	0.7VDD	-	VDD	V
Input voltage ' L ' level	Vil	0	-	0.3VDD	V
Output voltage ' H ' level	Voh	0.7VDD	-	VDD	V
Output voltage ' L ' level	Vol	-	-	0.3VDD	V
	Black mode(60Hz)	-	523	-	mW
Power consumption	Standby mode	-	467	-	uW
	Black light	-	1344	-	mW

Note 1:VIH/VIL: R0-R7,G0-G7,B0-B7,HSYNC,VSYNC,PCLK,DE,DISP. Note 2:VOH/VOL: X1,X2,Y1,Y2.

■ BACKLIGHT CHARACTERISTICS

Item	Symbol	Min.	Тур.	Max.	Unit	Condition
Forward voltage	Vf	-	22.4	-	V	21 LEDs
Forward current	If	-	60	75	mA	(7 LEDs (7 LEDs)
Power consumption	WBL	-	1344	-	mW	× ,
Operating life time	-	10000	20000	-	Hrs	3 LED parallel)



Note 2: Each LED : I_F =20 mA, V_F =22.4V

Note 3: I is defined for one channel LED.Optical performance should be evaluated at Ta= 25° C only. If LED is driven by high current, high ambient temperature & humidity condition. The life time of LED will be reduced.Operating life means brightness goes down to 50% initial brightness. Typical operating life time is estimated data.



Item		Symbol	Condition	Min	Тур	Max	Unit	Remark	Note
Response time Contrast ratio		Tr+Tf		-	40	60	ms	FIG 1.	4
		Cr	θ=0°	400	500	-		FIG 2.	1
Luminar uniform		δ WHITE	Ø=0° Ta=25℃	75	80	-	%	FIG 2.	3
Surface Lum	inance	Lv		200	280	-	cd/m ²	FIG 2.	2
			$\emptyset = 90^{\circ}$	50	60	-	deg	FIG 3.	
Viewing angle range	θ		60	70	-	deg	FIG 3.	6	
	Ø		60	70	-	deg	FIG 3.		
			$\emptyset = 180^{\circ}$	60	70	-	deg	FIG 3.	
	Red	Х		0.430	0.580	0.530			
		у		0.300	0.350	0.400			
	Green	X	θ=0°	0.295	0.345	0.395			
CIE (x, y)	Olech	у	Ø=0°	0.525	0.575	0.625		FIG 2.	5
chromaticity	Blue	Х		0.095	0.145	0.195		110 2.	5
	Diue	У	1 a - 25 C	0.065	0.115	0.165			
	White	Х	0.265 0.315 0.365						
	White	у		0.290	0.340	0.390			
NTSC	-	-	-	-	50	-	%	-	-

■ELECTRO-OPTICAL CHARACTERISTICS

Note 1. Contrast Ratio(CR) is defined mathematically as For more information see FIG 2.

Contrast Ratio = <u>Average Surface Luminance with all white pixels (P1, P2, P3, P4, P5)</u> Average Surface Luminance with all black pixels (P1, P2, P 3, P4, P5)

Note 2. Surface luminance is the LCD surface from the surface with all pixels displaying white. For more information see FIG 2.

Lv = Average Surface Luminance with all white pixels (P1, P2, P 3, P4, P5)

Note 3. The uniformity in surface luminance , δ WHITE is determined by measuring luminance at each test position 1 through 5, and then dividing the maximum luminance of 5 points luminance. For more information see FIG 2.

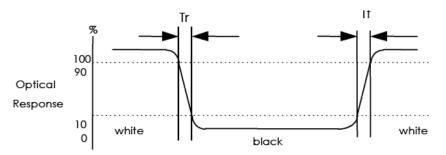
 $\delta \text{ WHITE} = \frac{\text{Minimum Surface Luminance with all white pixels (P1, P2, P 3, P4, P5)}}{\text{Maximum Surface Luminance with all white pixels (P1, P2, P 3, P4, P5)}}$

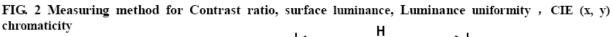
- Note 4. Response time is the time required for the display to transition from White to black(Rise Time, Tr) and from black to white(Decay Time, Tf). For additional information see FIG 1. The test equipment is Autronic-Melchers's ConoScope. Series.
- Note 5. CIE (x, y) chromaticity, The x, y value is determined by measuring luminance at each test position 1 through 5, and then make average value.
- Note 6. Viewing angle is the angle at which the contrast ratio is greater than 2. For TFT module the conrast ratio is greater than 10. The angles are determined for the horizontal or x axis and the vertical or y axis with respect to the z axis which is normal to the LCD surface. For more information see FIG 3.
- Note 7. For viewing angle and response time testing, the testing data is base on Autronic-Melchers's ConoScope. Series Instruments For contrast ratio, Surface Luminance, Luminance uniformity, CIE The test data is base on TOPCON's BM-5 photo detector.

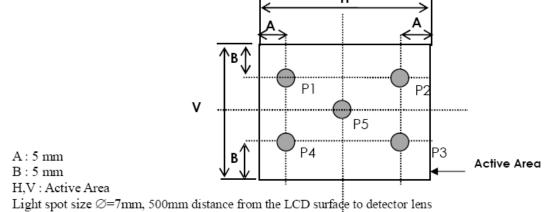


FIG. 1 The definition of Response Time

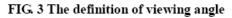
The response time is defined as the following figure and shall be measured by switching the input signal for "black" and "white".

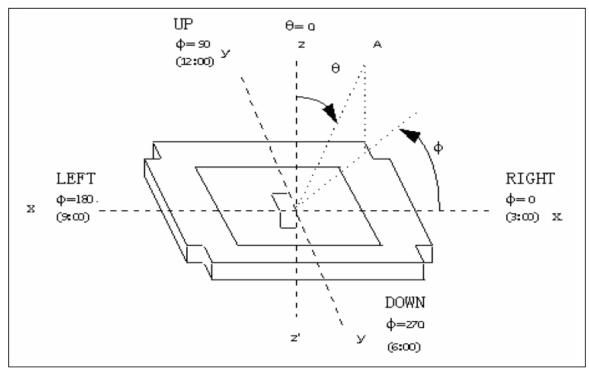






measurement instrument is TOPCON's luminance meter BM-5







■ INTERFACE DESCRIPTION

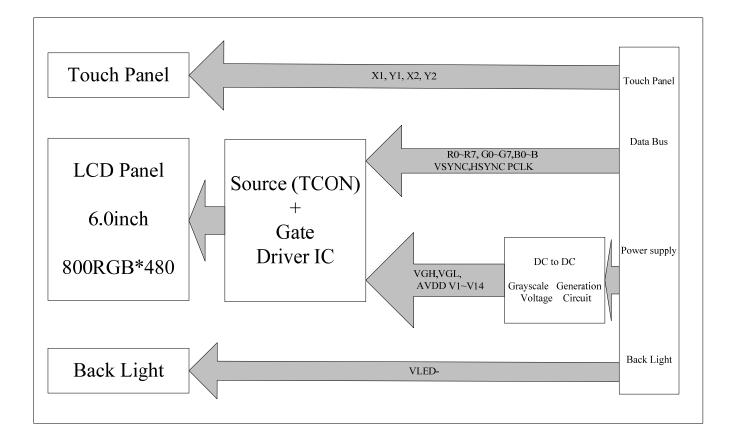
No	Symbol	I/O	Description	Comment
1	VLED-	Р	LED light cathode	
2	VLED+	Р	LED light anode	
3	GND	Р	Ground	
4	VDD	Р	Power supply 3.3V	
5	R0		Red data	
6	R1		Red data	
7	R2		Red data	
8	R3		Red data	
9	R4		Red data	
10	R5		Red data	
11	R6		Red data	
12	R7		Red data	
13	G0		Green data	
14	G1		Green data	
15	G2		Green data	
16	G3		Green data	
17	G4		Green data	
18	G5		Green data	
19	G6		Green data	
20	G7		Green data	
21	B0		Blue data	
22	B1	I	Blue data	
23	B2		Blue data	
24	B3		Blue data	
25	B4		Blue data	
26	B5		Blue data	
27	B6		Blue data	
28	B7		Blue data	
29	GND		Ground	
30	PCLK		Clock signal	
31	DISP		Display on/off	
32	HSYNC		Horizontal Synchronize signal	
33	VSYNC	I	Vertical Synchronize signal	
34	DE		Enable signal	
35	NC	-	No use	
36	GND	Р	Ground	
37	X1	0	Touch Panel Right side	
38	Y1	0	Touch Panel Bottom side	
39	X2	0	Touch Panel Left side	
40	Y2	0	Touch Panel Top side	

Note: I/O definition:

I----Input O----Output P----Power/Ground



BLOCK DIAGRAM





■ APPLICATION NOTES

1 INTERFACE TIMING

1.1 Data Input Timing

Symbol		Unit			
thd		800			
folk	Min.	Тур.	Max.		
ICIK	-	30	40	MHZ	
th		928			
thpw	1	48	-	PCLK	
thb	-	88	-	FULN	
thfp	-	40	-		
	fclk th thpw thb thfp	fclk Min. - th thpw 1 thb - thfp -	Min. Typ. - 30 th 928 thpw 1 48 thb - 88	Min. Typ. Max. - 30 40 th 928 thpw 1 48 - thb - 88 - thfp - 40 -	

Table 1.1 Horizontal input timing

Parameter	Symbol	Value			Unit
Farameter	Symbol	Min	Тур	Max	Onit
Vertical display area	tvd		480		Н
VSYNC period time	tv		525		
VSYNC pulse width	tvpw	-	3	-	Н
VSYNC Blanking(tvb)	tvb	-	32	-	Н
VSYNC Front porch (tvfp)	tvfp	-	13	-	H

Table 1.2 Vertical input timing

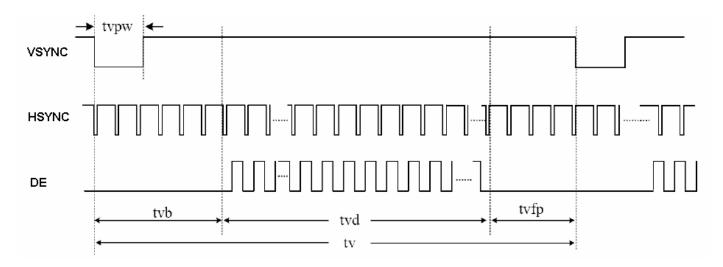


Figure 1.1 Vertical input timing



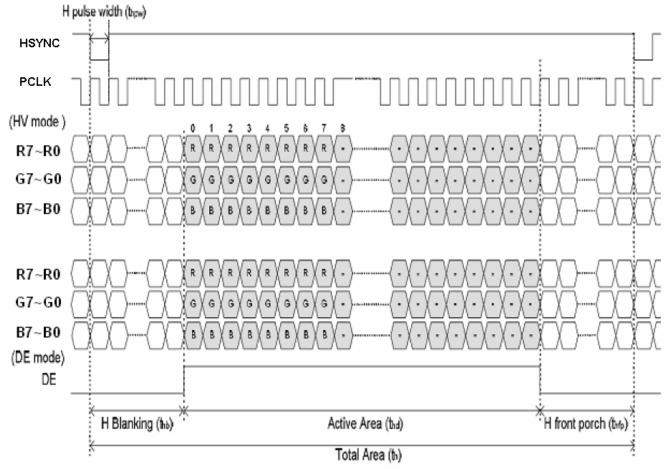
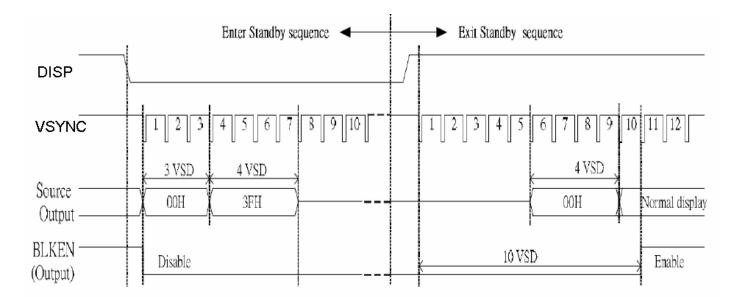


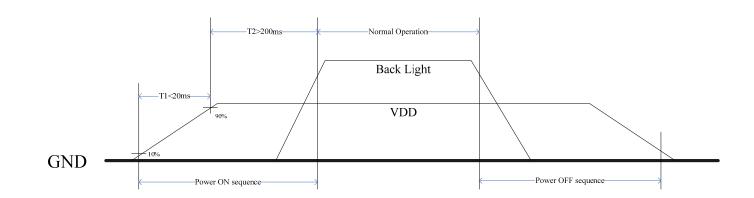
Figure 1.2 Horizontal input timing

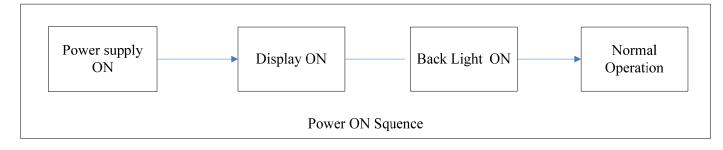
1.2 Enter And Exit Standby Mode Sequence

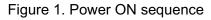




1.3 Power ON/OFF Sequence







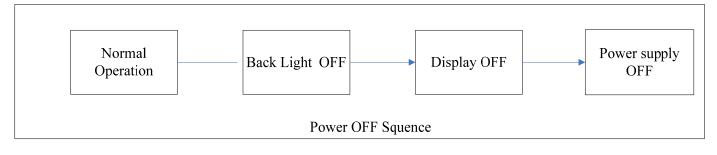


Figure 2. Power OFF sequence



■ RELIABILITY TEST

No.	Test Item	Test Condition	Remark
1	High Temperature Storage	$70\pm2^{\circ}C/240$ hours	IEC60068-2-1 GB2423.2
2	Low Temperature Storage	-30 ± 2 °C/240 hours	IEC60068-2-1 GB2423.1
3	High Temperature Operating	$60\pm2^{\circ}C/240$ hours	IEC60068-2-1 GB2423.2
4	Low Temperature Operating	$-20\pm2^{\circ}C/240$ hours	IEC60068-2-1 GB2423.1
5	Temperature Cycle storage	$-30 \pm 2^{\circ}C \sim 25 \sim 80 \pm 2^{\circ}C \times 100$ cycles (30 min.) (5 min.) (30 min.)	Start with cold temperature, End with high temperature, IEC60068-2-14 GB2423.22
6	Damp proof Test operating	$60^{\circ}\text{C} \pm 5^{\circ}\text{C} \times 90\%$ RH/240 hours	IEC60068-2-78 GB/T2423.3
7	Vibration Test (non-operation)	Frequency range:10Hz~55Hz, Stroke:1.5mm Sweep:10Hz~55Hz~10Hz 2 hours for each direction of X,Y,Z(6 hours for total)	IEC60068-2-6 GB/T2423.10
8	Package drop test	Height:60cm,1 corner,3 edges,6 surfaces	IEC60068-2-32,GB2423.8
9	ESD test (operation)	C=150pF,R=330Ω,5points/panel Air: ±8KV,5times Contact: ±4KV,5times(Environment: 15°C~35°C,30%~60%,86Kpa~106Kpa)	IEC61000-4-2 GB/T17626.2
10	Shock(non-operation)	Half sine wave:100G 6ms, $\pm X, \pm Y, \pm Z$ 3times each direction	IEC60068-2-27 GB/T2423.5

Note 1:Ts is the temperature of panel's surface. Note 2:Ta is the ambient temperature of sample.



■ INSPECTION CRITERION

MIT	OUTGOING QUALITY STANDARD	PAGE 1 OF 5
TITLE:FUNCTI	ONAL TEST & INSPECTION CRITERIA	MDS Product

This specification is made to be used as the standard acceptance/rejection criteria for Color mobile phone LCM.

1 Sample plan

Sampling plan according to GB/T2828.1-2003/ISO 2859-1: 1999 and ANSI/ASQC Z1.4-1993, normal level 2 and based on:

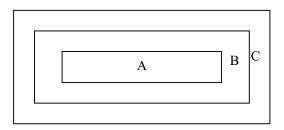
Major defect: AQL 0.65

Minor defect: AQL 1.5

2. Inspection condition

Viewing distance for cosmetic inspection is about 30cm with bare eyes, and under an environment of 20~40W light intensity, all directions for inspecting the sample should be within 45° against perpendicular line.

3. Definition of inspection zone in LCD.



Zone A: character/Digit area

Zone B: viewing area except Zone A (ZoneA+ZoneB=minimum Viewing area)

Zone C: Outside viewing area (invisible area after assembly in customer's product)

Fig.1 Inspection zones in an LCD.

Note: As a general rule, visual defects in Zone C are permissible, when it is no trouble for quality and assembly of customer's product.



OUTGOING QUALITY STANDARD				PAGE 2 OF 5			
TLE:F	UNCTIONAL	TEST & INSPECTION	N CRITERIA	MDS Product			
Inspe	ction standar	·ds					
4.1 Ma	jor Defect						
Item No	Items to be inspected	Inspection Standard			Classification of defects		
4.1.1	All functional defects	 No display Display abnormally Missing vertical, Short circuit Back-light no light 					
4.1.2	Missing	Missing component			Major		
4.1.3	Outline dimension	Overall outline dimen	-				
4.2 Cos	metic Defect						
Item No	Items to be inspected		Inspection Standa	rd	Classification of defects		
	Clear Spots	For dark/white spot, s as $\Phi = \frac{(x+y)}{2}$ 1.	_				
	Black and white Spot	I. Zone					
	defect Pinhole, Foreign Particle, Dirt under	Size(mm)	A	B C	Minor		
		Ф≤0.10	Ignore				
		0.10<Φ≤0.15	2	Income			
	polarizer	0.15<Φ≤0.20	1	Ignore			
4.2.1		Φ>0.20	0				
	Dim Spots	2.	1	I			
	Circle	2. Zone Acceptal		ble Qty			
	shaped and dim edged defects	Size(mm)	A B	С			
		Φ≤0.2	Ignore		Minor		
		0.20<Φ≤0.40	3				
		0.40<Φ≤0.60	2	Ignore			
		0.60<Φ≤0.80	1				
		0.80<Φ	0				

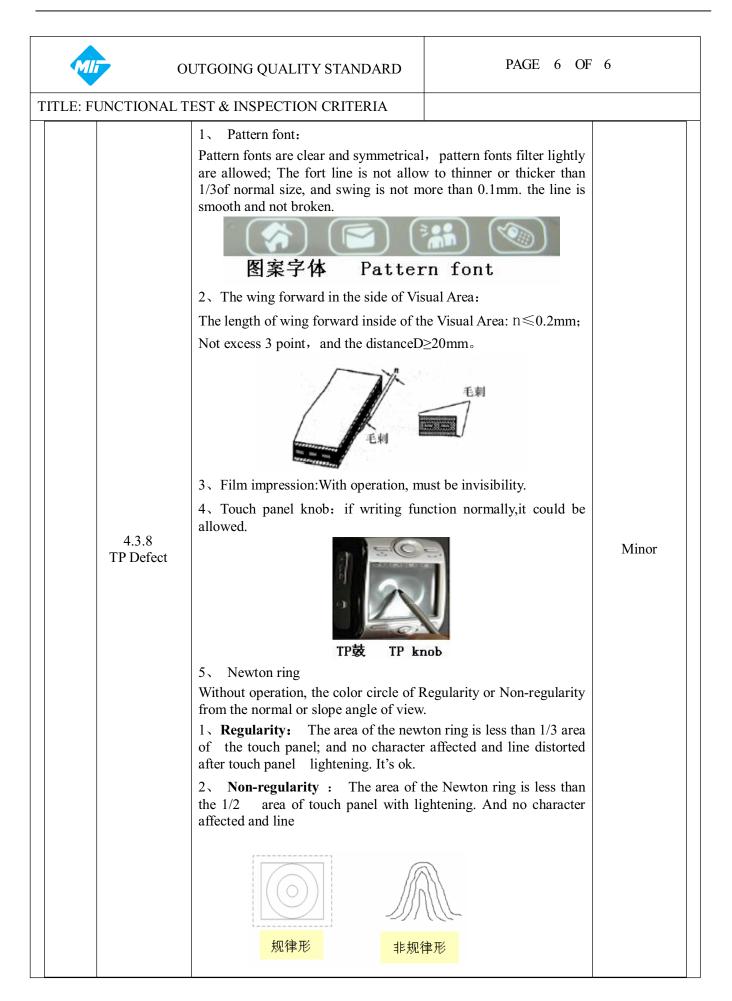


ГLE: F	FUNCTIONAL 7	EST & INSPECT	ION CRITERIA			MD	S Pro	duct
	smetic Defect							
Item No	Items to be inspected	Inspection Standard					Classification of defects	
	Line defect Black line,	Size(mm)		Acc	Acceptable Qty			
		L(Length)	W(Width)	A	Zone B			
	White line, Foreign	White line,		Igno	Ignore			
4.2.2	material	L≤3.0	0.02 <w≤0.03< td=""><td>2</td><td colspan="2">2</td><td>1</td><td>Minor</td></w≤0.03<>	2	2		1	Minor
	polarizer,	L≤2.0	0.03 <w≤0.05< td=""><td>1</td><td></td><td>Ignor</td><td>e</td><td></td></w≤0.05<>	1		Ignor	e	
			0.05 <w< td=""><td>Define a defe</td><td></td><td colspan="2">ot</td><td></td></w<>	Define a defe		ot		
4.2.3	Polarizer scratch			Acceptable Qty Zone A B C			Minor	
		L(Length)	W(Width)	A		С		Minor
					3	С		Minor
		Ignore 5.0 <l≤10.0< td=""><td>W(Width) W≤0.03 0.03 < W≤0.05</td><td>A H Ignore 2</td><td>3</td><td>С</td><td></td><td>Minor</td></l≤10.0<>	W(Width) W≤0.03 0.03 < W≤0.05	A H Ignore 2	3	С		Minor
		Ignore	W≤0.03	Ignore	3	C		Minor
		Ignore 5.0 <l≤10.0< td=""><td>W≤0.03 0.03<w≤0.05< td=""><td>Ignore 2</td><td>3</td><td></td><td></td><td>Minor</td></w≤0.05<></td></l≤10.0<>	W≤0.03 0.03 <w≤0.05< td=""><td>Ignore 2</td><td>3</td><td></td><td></td><td>Minor</td></w≤0.05<>	Ignore 2	3			Minor
		Ignore 5.0 <l≤10.0< td=""> L≤5.0</l≤10.0<>	W≤0.03 0.03 <w≤0.05 0.05<w≤0.08< td=""><td>Ignore 2 1 0</td><td>3</td><td></td><td></td><td>Minor</td></w≤0.08<></w≤0.05 	Ignore 2 1 0	3			Minor
		Ignore 5.0 <l≤10.0< td=""> L≤5.0</l≤10.0<>	$W \le 0.03$ 0.03 < W \le 0.05 0.05 < W \le 0.08 0.08 < W ween glass & pola	Ignore 2 1 0	3 Iş			Minor
	Polarize	Ignore $5.0 < L \le 10.0$ $L \le 5.0$ Air bubbles bet	$W \le 0.03$ 0.03 < W \le 0.05 0.05 < W \le 0.08 0.08 < W ween glass & pola	Ignore 2 1 0 rizer	3 Is			Minor
4.2.4	Polarize Air bubble	Ignore $5.0 < L \le 10.0$ $L \le 5.0$ Air bubbles bet2. Zone	W≤0.03 0.03 < W≤0.05 0.05 < W≤0.08 0.08 < W ween glass & pola	Ignore 2 1 0 rizer	3 Is	gnore		Minor
4.2.4		Ignore $5.0 < L \le 10.0$ $L \le 5.0$ Air bubbles bet2. ZoneSize(mm)	$W \le 0.03$ $0.03 < W \le 0.05$ $0.05 < W \le 0.08$ $0.08 < W$ ween glass & pola A Ignor	Ignore 2 1 0 rizer	3 I4	gnore C		
4.2.4		Ignore $5.0 < L \le 10.0$ $L \le 5.0$ Air bubbles bet2. ZoneSize(mm) $\Phi \le 0.2$	$W \le 0.03$ $0.03 < W \le 0.05$ $0.05 < W \le 0.08$ $0.08 < W$ ween glass & pola Ac A $Ignor$ 2	Ignore 2 1 0 rizer	3 I4	gnore		



M		OUTGOING QUALITY STANDARD P A G E	4 OF 6		
TITLE:FU	FITLE:FUNCTIONAL TEST & INSPECTION CRITERIA MDS Press				
4.3. Cos	smetic Defect				
Item No	Items to be inspected	Inspection Standard	Classification of defects		
4.3.5	Glass defect	(i) Chips on corner (i) Chips on corner X Y Z ≤ 2.0 ≤ 8 Disregard Notes: S=contact pad length Chips on the corner of terminal shall not be allowed to extend into the ITO pad or expose perimeter seal. (ii)Usual surface cracks X Y Z ≤ 3.0 <inner border="" disregard<="" line="" of="" seal="" td="" the=""><td>Minor</td></inner>	Minor		
	Dorto	 (iii) Crack Cracks tend to break are not allowed. Image: second se	Major		
4.3.6	Parts alignment	 beyond lead pattern. 2) Not allow chip or solder component is off center more than 50% of the pad outline. 	Minor		
4.3.7	SMT	According to the <acceptability assemblies="" electronic="" of=""> IPC-A-610C class 2 standard. Component missing or function defect are Major defect, the others are Minor defect.</acceptability>			







■ PRECAUTIONS FOR USING LCD MODULES

1 Handing Precautions

- 1.1 The display panel is made of glass and polarizer. As glass is fragile. It tends to become or chipped during handling especially on the edges. Please avoid dropping or jarring. Do not subject it to a mechanical shock by dropping it or impact.
- 1.2 If the display panel is damaged and the liquid crystal substance leaks out, be sure not to get any in your mouth. If the substance contacts your skin or clothes, wash it off using soap and water.
- 1.3 Do not apply excessive force to the display surface or the adjoining areas since this may cause the color tone to vary. Do not touch the display with bare hands. This will stain the display area and degraded insulation between terminals (some cosmetics are determined to the polarizer).
- 1.4 The polarizer covering the display surface of the LCD module is soft and easily scratched. Handle this polarizer carefully. Do not touch, push or rub the exposed polarizers with anything harder than an HB pencil lead (glass, tweezers, etc.). Do not put or attach anything on the display area to avoid leaving marks on it. Condensation on the surface and contact with terminals due to cold will damage, stain or dirty the polarizer. After products are tested at low temperature they must be warmed up in a container before coming in to contact with room temperature air.
- 1.5 If the display surface becomes contaminated, breathe on the surface and gently wipe it with a soft dry cloth. If it is heavily contaminated, moisten cloth with one of the following solvents
 - Isopropyl alcohol
 - Ethyl alcohol

Do not scrub hard to avoid damaging the display surface.

- 1.6 Solvents other than those above-mentioned may damage the polarizer. Especially, do not use the following.
 - Water
 - Ketone
 - Aromatic solvents

Wipe off saliva or water drops immediately, contact with water over a long period of time may cause deformation or color fading. Avoid contact with oil and fats.

- 1.7 Exercise care to minimize corrosion of the electrode. Corrosion of the electrodes is accelerated by water droplets, moisture condensation or a current flow in a high-humidity environment.
- 1.8 Install the LCD Module by using the mounting holes. When mounting the LCD module make sure it is free of twisting, warping and distortion. In particular, do not forcibly pull or bend the I/O cable or the backlight cable.
- 1.9 Do not attempt to disassemble or process the LCD module.
- 1.10 NC terminal should be open. Do not connect anything.
- 1.11 If the logic circuit power is off, do not apply the input signals.
- 1.12 Electro-Static Discharge Control, Since this module uses a CMOS LSI, the same careful attention should be paid to electrostatic discharge as for an ordinary CMOS IC. To prevent destruction of the elements by static electricity, be careful to maintain an optimum work environment.

- Before removing LCM from its packing case or incorporating it into a set, be sure the module and your body have the same electric potential. Be sure to ground the body when handling the LCD modules.

- Tools required for assembling, such as soldering irons, must be properly grounded. Make certain the AC power source for the soldering iron does not leak. When using an electric screwdriver to attach LCM, the screwdriver should be of ground potentiality to minimize as much as possible any transmission of electromagnetic waves produced sparks coming from the commutator of the motor.

- To reduce the amount of static electricity generated, do not conduct assembling



Ver 2.2

and other work under dry conditions. To reduce the generation of static electricity be careful that the air in the work is not too dry. A relative humidity of 50%-60% is recommended. As far as possible make the electric potential of your work clothes and that of the work bench the ground potential.

- The LCD module is coated with a film to protect the display surface. Exercise care when peeling off this protective film since static electricity may be generated.

1.13 Since LCM has been assembled and adjusted with a high degree of precision, avoid applying excessive shocks to the module or making any alterations or modifications to it.

- Do not alter, modify or change the shape of the tab on the metal frame.

- Do not make extra holes on the printed circuit board, modify its shape or change the positions of components to be attached.

- Do not damage or modify the pattern writing on the printed circuit board.

- Absolutely do not modify the zebra rubber strip (conductive rubber) or heat seal connector.

- Except for soldering the interface, do not make any alterations or modifications with a soldering iron.

- Do not drop, bend or twist the LCM.

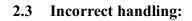


- 2 Handling precaution for LCM
 - 2.1 LCM is easy to be damaged. Please note below and be careful for handling.
 - 2.2 Correct handling:





As above picture, please handle with anti-static gloves around LCM edges.





Please don't touch IC directly.



Please don't hold the surface of panel.



Please don't hold the surface of IC.



Please don't stack LCM.



Please don't stretch interface of output, such as FPC cable.



Please don't operate with sharp stick such as pens.



3 Storage Precautions

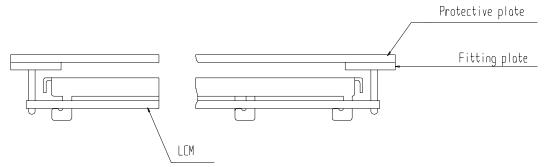
- 3.1 When storing the LCD modules, the following precaution are necessary.
 - 3.1.1 Store them in a sealed polyethylene bag. If properly sealed, there is no need for the desiccant.
 - 3.1.2 Store them in a dark place. Do not expose to sunlight or fluorescent light, keep the temperature between 0°C and 35°C, and keep the relative humidity between 40%RH and 60%RH.
 - 3.1.3 The polarizer surface should not come in contact with any other objects (We advise you to store them in the anti-static electricity container in which they were shipped).
- 3.2 Others 其它
 - 3.2.1 Liquid crystals solidify under low temperature (below the storage temperature range) leading to defective orientation or the generation of air bubbles (black or white). Air bubbles may also be generated if the module is subject to a low temperature.
 - 3.2.2 If the LCD modules have been operating for a long time showing the same display patterns, the display patterns may remain on the screen as ghost images and a slight contrast irregularity may also appear. A normal operating status can be regained by suspending use for some time. It should be noted that this phenomenon does not adversely affect performance reliability.
 - 3.2.3 To minimize the performance degradation of the LCD modules resulting from destruction caused by static electricity etc., exercise care to avoid holding the following sections when handling the modules.
 - 3.2.3.1 Exposed area of the printed circuit board.
 - 3.2.3.2 -Terminal electrode sections.

4 USING LCD MODULES

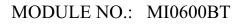
4.1 Installing LCD Modules

The hole in the printed circuit board is used to fix LCM as shown in the picture below. Attend to the following items when installing the LCM.

4.1.1 Cover the surface with a transparent protective plate to protect the polarizer and LC cell.

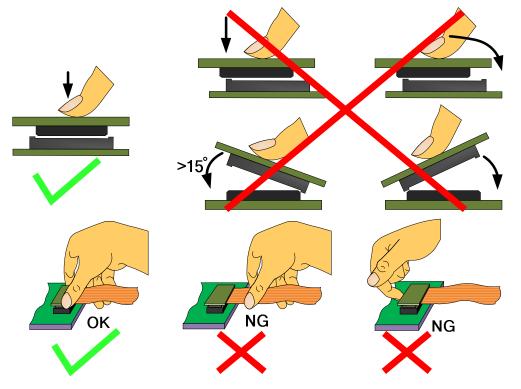


4.1.2 When assembling the LCM into other equipment, the spacer to the bit between the LCM and the fitting plate should have enough height to avoid causing stress to the module surface, refer to the individual specifications for measurements. The measurement tolerance should be ± 0.1 mm.





- Ver 2.2
- 4.2 Precaution for assemble the module with BTB connector: Please note the position of the male and female connector position, don't assemble or assemble like the method which the following picture shows





4.3	Precaution	for	soldering	the	LCM	
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	Manual soldering	Machine drag soldering	Machine press soldering
No RoHS	290°C ~350°C.	330°C ~350°C.	300°C ~330°C.
Product	Time : 3-5S.	Speed : 15-17 mm/s.	Time : 3-6S.
FIOduct			Press: 0.8~1.2Mpa
RoHS	340°C ~370°C.	350°C ~370°C.	330°C ~360°C.
Product	Time : 3-5S.	Speed : 15-17 mm/s.	Time : 3-6S.
TIOduct			Press: 0.8~1.2Mpa

- 4.3.1 If soldering flux is used, be sure to remove any remaining flux after finishing to soldering operation (This does not apply in the case of a non-halogen type of flux). It is recommended that you protect the LCD surface with a cover during soldering to prevent any damage due to flux spatters.
- 4.3.2 When soldering the electroluminescent panel and PC board, the panel and board should not be detached more than three times. This maximum number is determined by the temperature and time conditions mentioned above, though there may be some variance depending on the temperature of the soldering iron.
- 4.3.3 When remove the electroluminescent panel from the PC board, be sure the solder has completely melted, the soldered pad on the PC board could be damaged.
- 4.4 Precautions for Operation
 - 4.4.1 Viewing angle varies with the change of liquid crystal driving voltage (VLCD). Adjust VLCD to show the best contrast.
 - 4.4.2 It is an indispensable condition to drive LCD's within the specified voltage limit since the higher voltage then the limit cause the shorter LCD life. An electrochemical reaction due to direct current causes LCD's undesirable deterioration, so that the use of direct current drive should be avoided.
 - 4.4.3 Response time will be extremely delayed at lower temperature than the operating temperature range and on the other hand at higher temperature LCD's show dark color in them. However those phenomena do not mean malfunction or out of order with LCD's, which will come back in the specified operating temperature.
 - 4.4.4 If the display area is pushed hard during operation, the display will become abnormal. However, it will return to normal if it is turned off and then back on.
 - 4.4.5 A slight dew depositing on terminals is a cause for electro-chemical reaction resulting in terminal open circuit. Usage under the maximum operating temperature, 50%RH or less is required.
 - 4.4.6 Input logic voltage before apply analog high voltage such as LCD driving voltage when power on. Remove analog high voltage before logic voltage when power off the module. Input each signal after the positive/negative voltage becomes stable.
 - 4.4.7 Please keep the temperature within the specified range for use and storage. Polarization degradation, bubble generation or polarizer peel-off may occur with high temperature and high humidity.

4.5 Safety

- 4.5.1 It is recommended to crush damaged or unnecessary LCDs into pieces and wash them off with solvents such as acetone and ethanol, which should later be burned.
- 4.5.2 If any liquid leaks out of a damaged glass cell and comes in contact with the hands, wash off thoroughly with soap and water.



4.6 Limited Warranty

Unless agreed between Multi-Inno and the customer, Multi-Inno will replace or repair any of its LCD modules which are found to be functionally defective when inspected in accordance with Multi-Inno LCD acceptance standards (copies available upon request) for a period of one year from date of production. Cosmetic/visual defects must be returned to Multi-Inno within 90 days of shipment. Confirmation of such date shall be based on data code on product. The warranty liability of Multi-Inno limited to repair and/or replace on the terms set forth above. Multi-Inno will not be responsible for any subsequent or consequential events.

- 4.7 Return LCM under warranty
 - 4.7.1 No warranty can be granted if the precautions stated above have been disregarded. The typical examples of violations are :
 - 4.7.1.1 Broken LCD glass.
 - 4.7.1.2 PCB eyelet is damaged or modified.
 - 4.7.1.3 -PCB conductors damaged.
 - 4.7.1.4 Circuit modified in any way, including addition of components.
 - 4.7.1.5 PCB tampered with by grinding, engraving or painting varnish.
 - 4.7.1.6 Soldering to or modifying the bezel in any manner.
 - 4.7.2 Module repairs will be invoiced to the customer upon mutual agreement. Modules must be returned with sufficient description of the failures or defects. Any connectors or cable installed by the customer must be removed completely without damaging the PCB eyelet, conductors and terminals.

PACKING SPECIFICATION

Please consult our technical department for detail information.

PRIOR CONSULT MATTER

- 1 For Multi-Inno standard products, we keep the right to change material, process ... for improving the product property without prior notice to our customer.
- 2 For OEM products, if any changes are needed which may affect the product property, we will consult with our customer in advance.
- 3 If you have special requirement about reliability condition, please let us know before you start the test on our samples.